



DSRC / C-V2X / V2V / V2X / V2I 5900MHz Ceramic Chip Antenna

Part No:

CA.51

Description:

5.9GHz C-V2X Ceramic SMD Mount Chip Antenna

Features:

5850MHz to 5925MHz
Peak Gain 2dBi
Stable and Reliable Performance
Linear Polarized & High Efficiency
Low Profile, Compact Size
Manufactured in an IATF16949 Approved Facility
Dimensions: 1.6*0.8*0.3mm



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1. Introduction



The Taoglas CA.51 5.9GHz is a ceramic chip antenna specifically designed for C-V2X (& DSRC) applications and exhibits high-efficiency in a miniature SMD mount ceramic antenna with a small footprint requirement. This ceramic chip antenna uses the main PCB as its ground plane, thereby increasing antenna efficiency and decreasing the assembly cost. It is tuned for different PCB sizes by simply changing the value of the matching circuit. At 1.6mm*0.8mm*0.3mm, it is one of the smallest antennas available worldwide. This antenna is delivered on tape and reel.

C-V2X is the communications medium of choice for active safety V2V/V2X (Vehicle-to-Vehicle and Vehicle-to-Other) systems. Primarily allocated for vehicle safety applications, C-V2X supports high-speed, low-latency, short-range, V2V/V2X wireless communications.

This antenna can be mounted with no performance degradation in either orientation as long as the antenna is soldered correctly via Surface mounting. Please see the integration instructions section for further detail regarding the optimum way to integrate this antenna into your device.

For further optimization to customer-specific device environments and for support to integrate and test this antennas performance in your device, contact your regional Taoglas Customer Services Team.

Applications:

IEEE 802.11p (WAVE- Wireless Access in the Vehicular Environment)

DSRC (Dedicated Short Range Communication) systems for V2V / V2I / V2X

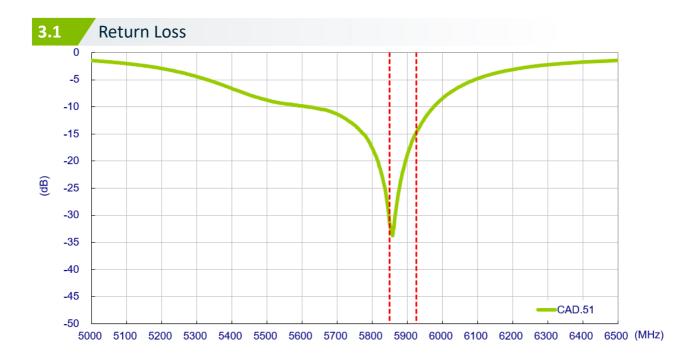


2. Specifications

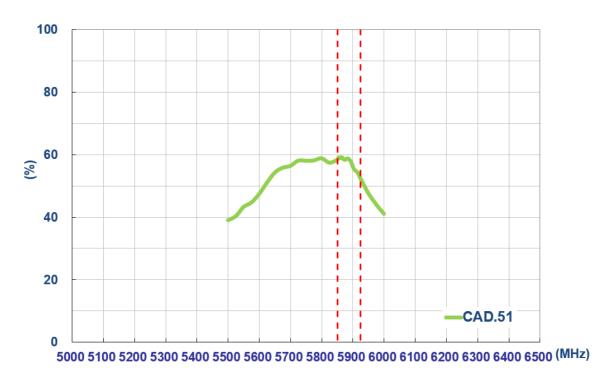
| Antenna | | | | | |
|---|----------------------------|--|--|--|--|
| Frequency (MHz) | 5850-5925 MHz | | | | |
| | Efficiency (%) | | | | |
| 40 x 40 mm Ground Plane | 57.08 | | | | |
| | Average Gain (dB) | | | | |
| 40 x 40 mm Ground Plane | -2.44 dB (typical) | | | | |
| | Peak Gain (dBi) | | | | |
| 40 x 40 mm Ground Plane | 2.87 dBi (typical) | | | | |
| VSWR | 2 max. | | | | |
| Impedance (Ω) | 50Ω | | | | |
| Polarization | Linear | | | | |
| Radiation Pattern | Omni | | | | |
| Input Power(W) | 2 | | | | |
| | Mechanical | | | | |
| Dimensions (mm) | 1.6 x 0.8 x 03 | | | | |
| Ground plane (mm) | 40 x 40 (Recommended) | | | | |
| Material | Ceramic | | | | |
| Environmental | | | | | |
| Temperature Range | -40°C to 85°C | | | | |
| Temperature Coefficient of Frequency (ppm/°C) | 0±20 max. (@-40°C to 85°C) | | | | |
| Humidity | Non-condensing 65°C 95% RH | | | | |
| Moisture Sensitivity Level | 3 (168 Hours) | | | | |



3. Antenna Characteristics



3.2 Efficiency



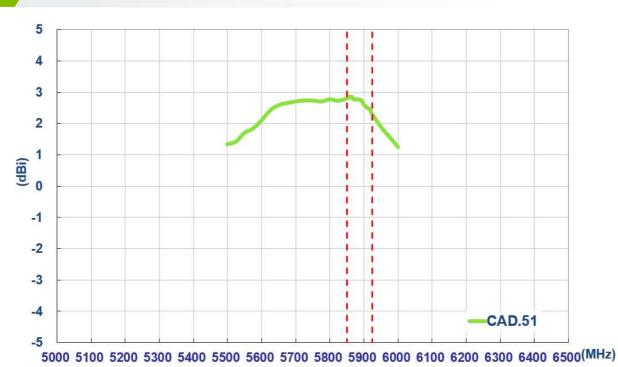


3.3 Average Gain



5000 5100 5200 5300 5400 5500 5600 5700 5800 5900 6000 6100 6200 6300 6400 6500 (MHz)

3.4 Peak Gain





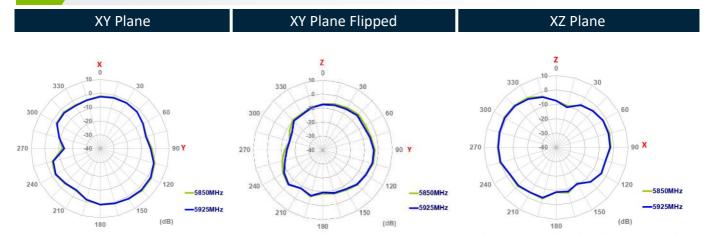
4. Radiation Patterns

4.1 Test Setup – Antenna on Evaluation Board

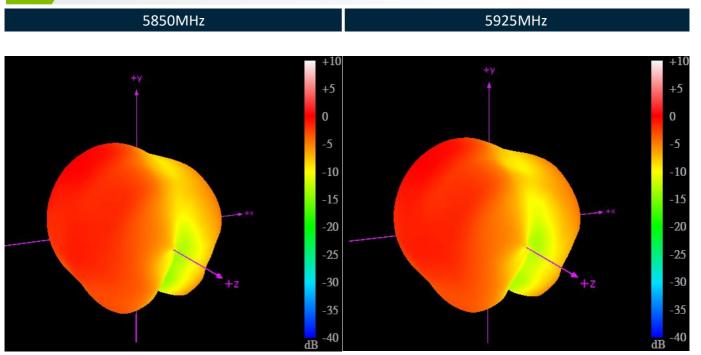




4.2 5850 - 5925MHz Radiation Patterns



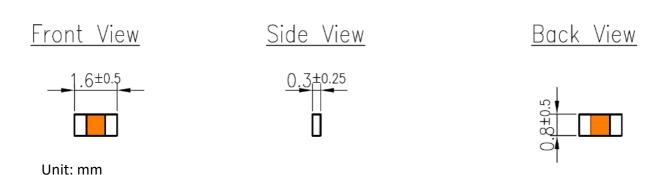
4.3 3D Radiation Pattern



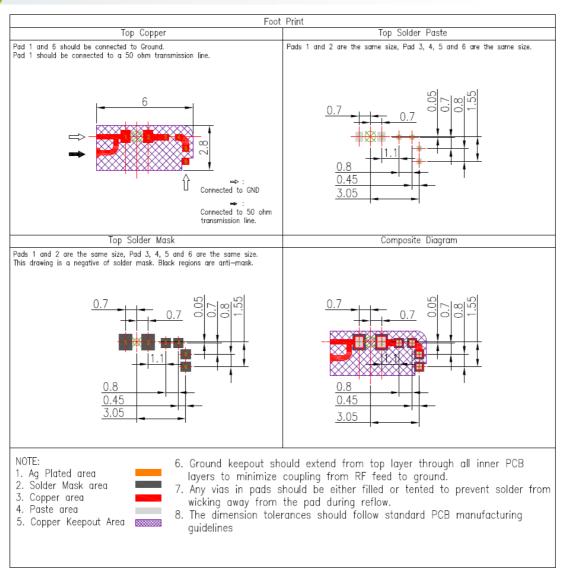


5. Mechanical Drawing – Antenna

5.1 Antenna Dimension and Drawing



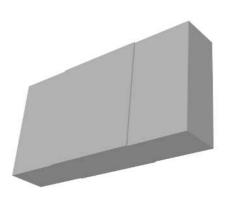
5.2 Antenna Footprint

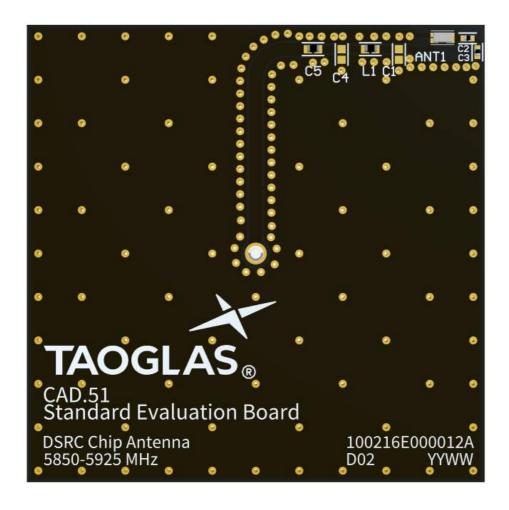


^{*}Taoglas is able to provide CAD drawing file to customers for evaluation.



Antenna Integration Guide



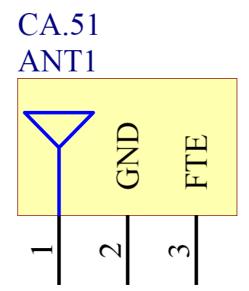




6.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 3 pins with all three pins as functional.

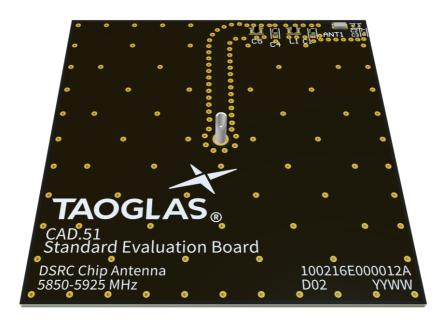
| Pin | Description |
|-----|-------------|
| 1 | RF Feed |
| 2 | Ground |
| 3 | FTE |





6.2 Antenna Integration

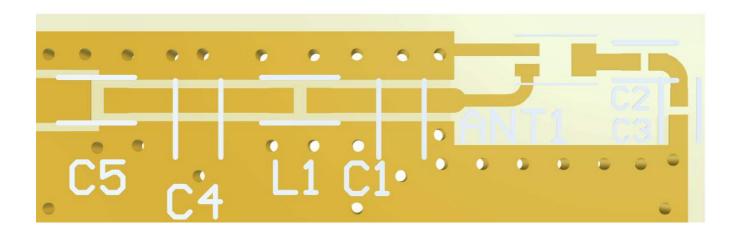
Whatever the size of the PCB, the antenna should ideally be placed on the PCB's longest side, to take advantage of the ground plane. Optimized matching components can be placed as shown.



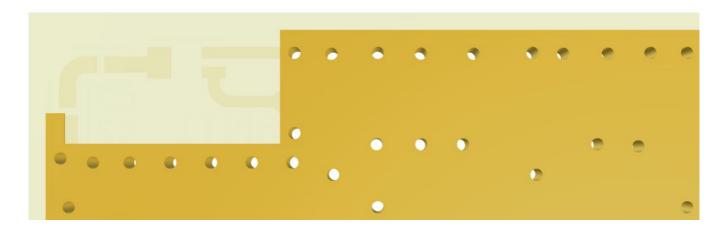


6.3 PCB Layout

The footprint and clearance on the PCB must meet the layout drawing in (Footprint Drawing). Note the placement of the optimized components. L1 is placed as close as possible to the RF feed (pad 1) but still within the transmission line. C5 is then placed tightly in series after that. C2 is placed as close as possible to the Tuning feed (pad 3) followed by C3 connecting to ground. C1 & C4 are optional components but the footprints are recommended in case they are needed.



Topside

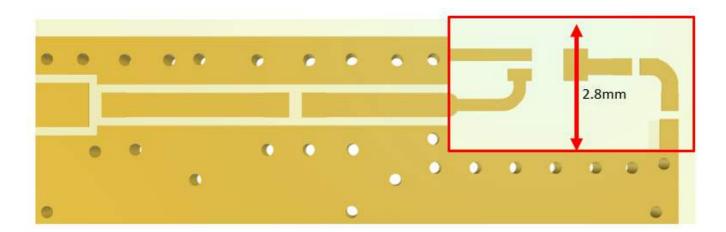


Bottom Side

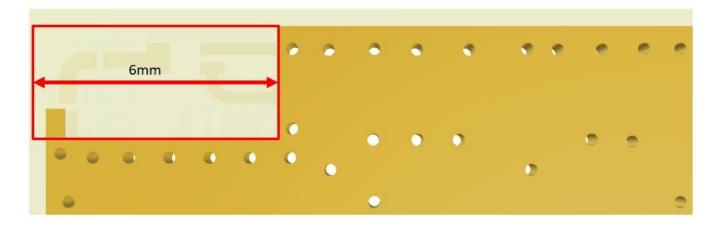


6.4 PCB Keep Out

Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 6mm in width and 2.6mm in length from the corner of the PCB. This clearance area includes the bottom side and ALL internal layers on the PCB.



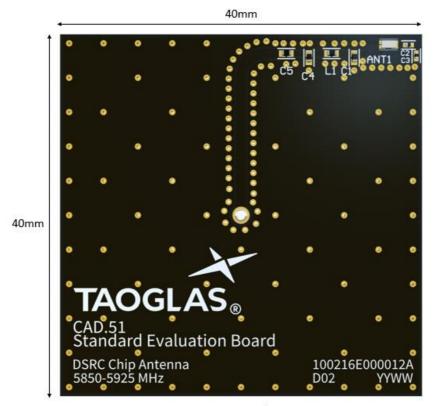
Topside



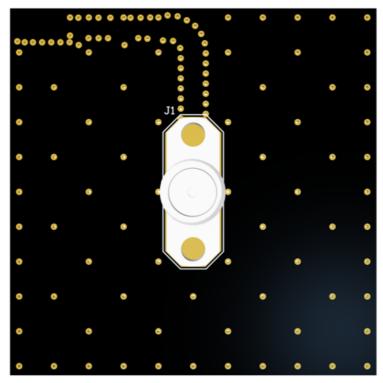
Bottom Side

Evaluation Board

6.5



Topside



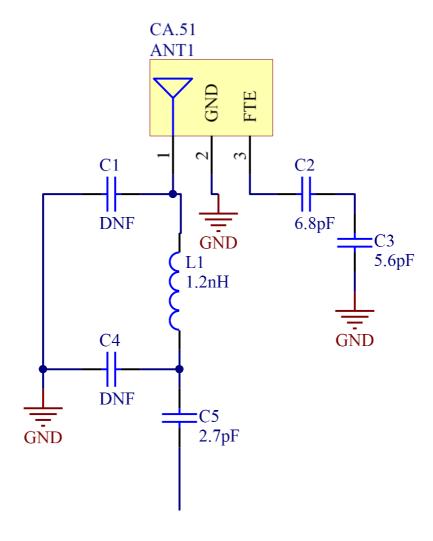
Bottom Side

Evaluation Board Matching Circuit

6.6

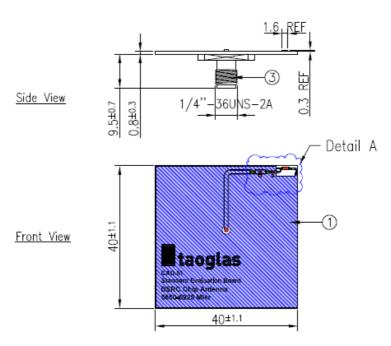
A matching component (L1) in series with the CA.51 is required for the antenna to have optimal performance on the evaluation board, located outside of the ground plane in the space specified in the above images. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the cellular module and the edge of the ground plane.

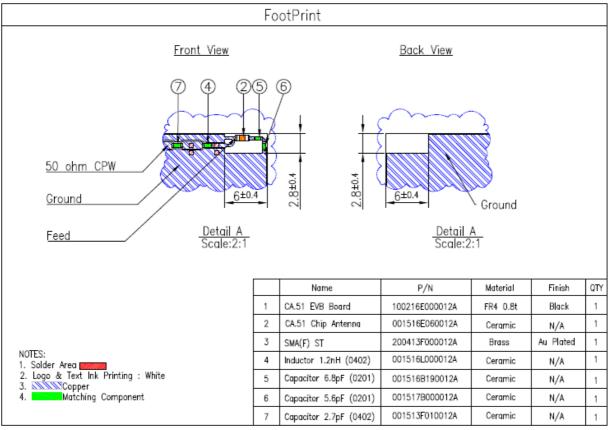
| Designator | Туре | Value | Manufacturer | Manufacturer Part Number |
|------------|-----------|-------|--------------|--------------------------|
| L1 | Inductor | 8.7nH | TDK | |
| C1, C4 | Capacitor | DNF | - | - |
| C2 | Capacitor | 6.8pF | Murata | GRM0335C1H6R8CA01D |
| C3 | Capacitor | 5.6pF | Murata | GRM0335C1H5R6CA01D |
| C5 | Capacitor | 2.7pF | Murata | GRM1555C1H2R7CA01D |





7. Mechanical Drawing – Evaluation Board

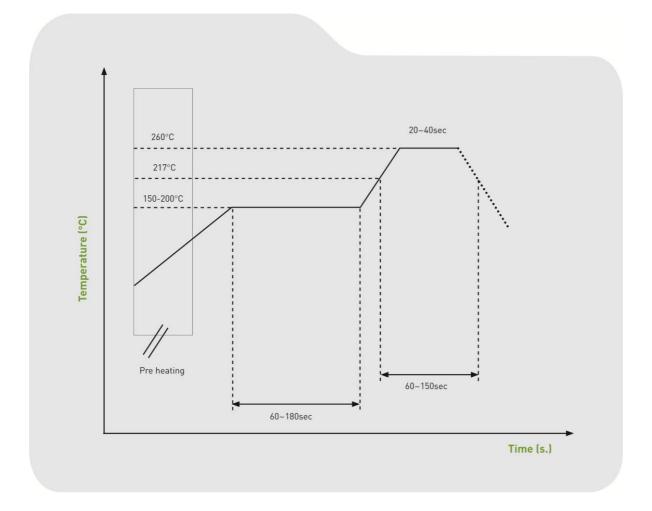






8. Soldering Conditions

Typical Soldering profile for lead-free process:

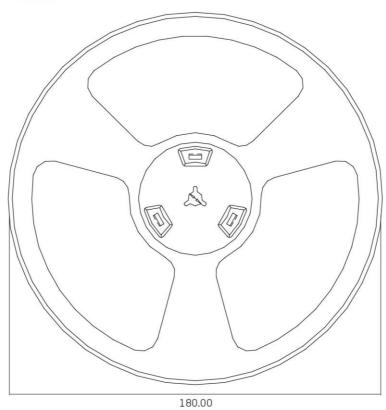


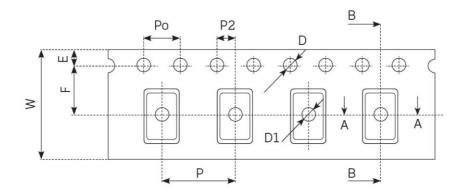


Packaging

5000 pc CA.51 per reel Dimensions - Ø180*11mm

Weight - 159.8g





W: 12.00mm P: 8.00mm E: 1.75mm F: 5.50mm P2: 2.00mm D : 1.50mm D1:

Po: 4.00mm

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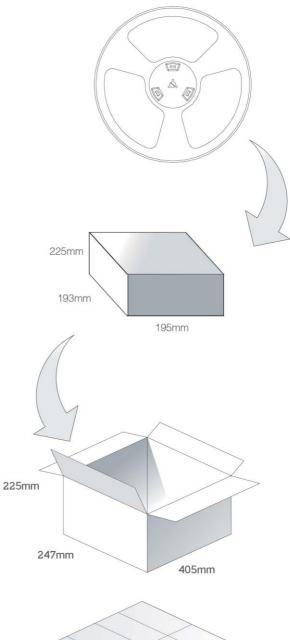


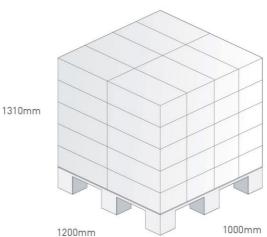
5000 pcs CA.51 reel Dimensions - 180*180*11mm Weight - 159.8g

50,000 pcs CA.51 / 10 Reel in small box Dimensions - 193*225*195mm Weight - 1.6Kg

2 small boxes, 100,000 pcs in one carton Carton Dimensions - 247*405*225mm Weight - 3.2Kg

Pallet Dimensions 1200*1000*1310mm 40 Cartons per Pallet 8 Cartons per layer 5 Layers







Changelog for the datasheet

SPE-17-8-032 - CA.51

| Revision: D (Current Version) | | |
|-------------------------------|-------------------------|--|
| Date: | 2021-10-04 | |
| Changes: | Integration Guide Added | |
| Changes Made by: | Cesar Sousa | |

Previous Revisions

| Revision: C | | |
|------------------|--------------------|--|
| Date: | 2021-10-04 | |
| Changes: | Format Change, MSL | |
| Changes Made by: | Erik Landi | |

| Revision: B | | |
|------------------|------------------|--|
| Date: | 2019-10-25 | |
| Changes: | Updated to C-V2X | |
| Changes Made by: | Jack Conroy | |

| Revision: A (Original First Release) | | |
|--------------------------------------|-----------------|--|
| Date: | 2017-05-22 | |
| Notes: | Initial Release | |
| Author: | STAFF | |



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